

NEW!

INTEGRATED 3D LASER PROFILER



SRI Series>



About SSZN

Since its establishment, SinceVision has taken 3D industrial sensor as the entry point, and launched 3D laser profiler (line laser), laser displacement sensor (point laser), through-beam edge sensor (deviation rectifying sensor) successively. In 2021, SinceVision entered the research and defense market and launched several product lines such as high-speed camera, totaling dozens of product series into the batch sales stage. At present, the products developed and produced have successfully broken the foreign monopoly, and become the leader of Chinese brand. In addition, some of the performance parameters of the mature products represented by the line laser have achieved world leadership, and gradually become a new benchmark to lead the development of the industry.

Today, the SinceVision brand is gradually becoming familiar to the automation people. We have served hundreds of customers, among which the terminal has covered domestic and foreign consumer electronics, carp electricity, photovoltaic major head brands. At present, we are sparing no effort to promote the refinement of product solutions based on niche areas, using our products and services to empower more fields. From semiconductor/panel, to automobile/railway; from plastic/film, to food/textile, to contribute to the cost reduction and efficiency of more industries. With the rise of labor cost and product quality upgrade, the future of industrial automation is unstoppable. With years of experience in R&D of 3D industrial sensors, Deep Vision has precipitated a comprehensive R&D platform involving optics, mechanics, electricity and software, as well as a mature product control system. In the future, Deep Vision will spare no effort to improve the R&D and production system, and strive to build a world-class industrial product R&D team. With the ultimate craftsmanship of Deep Vision people, we will continue to tackle high-end sensors, so that Chinese automation has a national brand available and a national brand can be trusted.

In order to provide our customers with fast and convenient services, we have set up many offices in China and overseas.

China

Shenzhen, Suzhou (Kunshan), Shanghai, Wuxi, Beijing, Chengdu, Ningde, Taiwan, Wuhan, Xi'an, Hefei, Dongguan

Overseas

South Korea, Vietnam, Thailand, Malaysia, Singapore

MILESTONE

2014

2016

2017

2018

April

Shenzhen SinceVision Technology Co.,Ltd. was officially established

March

Released the first generation of 3D Laser Profiler the SR7000 series.

March

Obtained the titles of "National High-tech Enterprise" and "Shenzhen Industrial Stable Growth Enterprise."

March

Released 3D laser profile the SR8000 series

March

SinceVision completed Round A financing

2021

2020

2019

March

Released 3D Laser Profiler the SR9000 series

September

SinceVision completed Round B financing

December

Released Laser Displacement Sensor - the SD series

March

Released 3D Laser Profiler the SR5000 series

June

Released Spectral Confocal

Displacement Sensor - the SC series

December

Established offices in Chengdu and Beijing, expanding services to the Southwest and North China regions.

March

The East China office was officially established in Kunshan to serve the Yangtze River Delta region.

November

SinceVision completed Round A+ financing

December

Released Laser Displacement Sensor the SG series and the SGI series

022

2023

2024

April

SinceVision completed Round B+ financing, co-led by MPC and GL Ventures. SinceVision entered the scientific research and defense markets, launching the first generation of High-Speed Camera - the SH6 series.

September

SinceVision obtained "CE Certification," "FCC Certification," "KC Certification," "Precision Certification," "ISO9001 Certification," "ISO14001 Certification," and "Social Accountability Management System Certification."

December

Released Through-Beam Edge Sensor - the SE1 series Established offices in Dongguan, Hefei, Xi'an, and other regions, covering nationwide services.

June

Released High-Speed Camera the SH3 series and Through-Beam Edge Sensor- the SE2 series

September

SinceVision completed Round C financing, led by the Advanced Manufacturing Fund managed by SDIC Fund Management Co., Ltd., with follow-on investment from GL Ventures.SinceVision was awarded the title of "National new special 'Small Giant' Enterprise."

October

Formally established the International Department, developing markets in Southeast Asia and Europe, with a service network covering the globe.

February

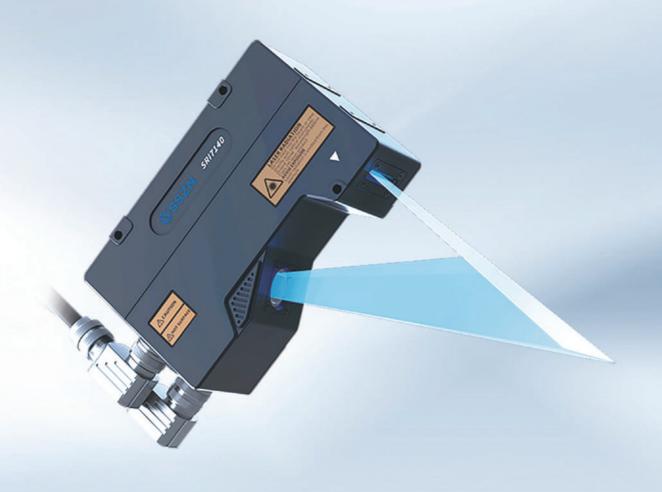
Released 3D Laser Profiler the SRI series

March

Released white light spot photoelectric sensor - the SS1series and Laser Displacement Sensor - the SDC series

June

Released High-Speed Camera-the SH2 series and Spectral Confocal Displacement Sensor- the SCI serie

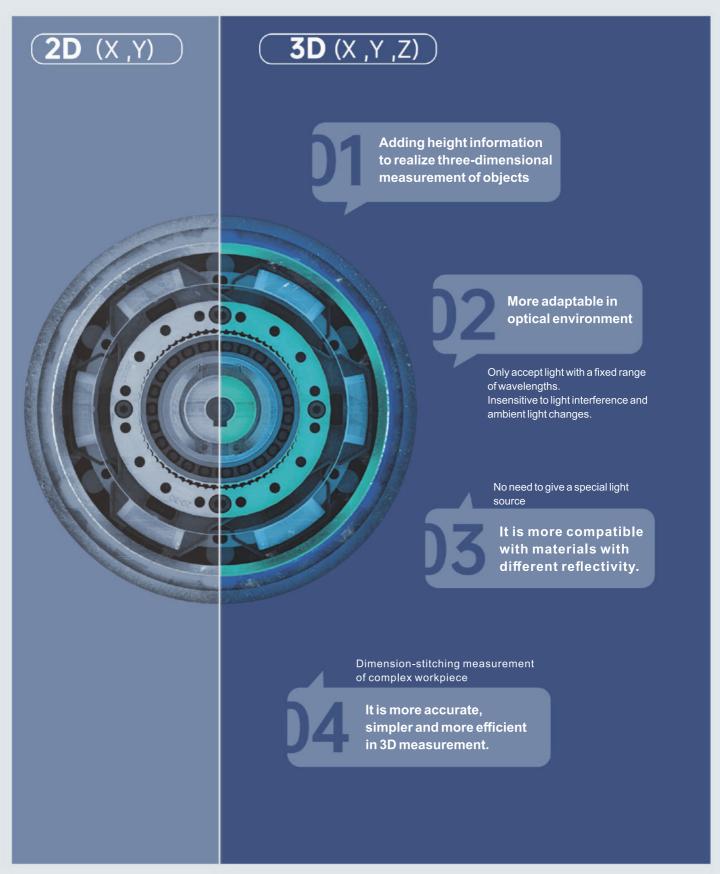




Working Principle

The optical system inside the sensor focuses the laser beam into a stable static line. The image sensor captures the laser line information projected by the laser emitter on the surface of the object, and analyzes the distance (Z-axis) and line position (X-axis) in real time. It outputs a fixed origin two-dimensional coordinate and combines it with the movement information of the measured object or the sensor to achieve accurate 3D measurement.

The development of 2D detection to 3D detection is an inevitable trend in the future.



50% Installation space

Highly integrated to save more than 50% installation space.

3200 Contour points

Ultra-high linear laser resolution Accurately restore the target shape

Ultra-high speed Highest sampling frequency of 67kHz

67kHz Sampling frequency 30 million times bending

High flexible cable Bending times up to 30 million

IP67 Protection level

IP67 rating provides a high level of protection against both dust and water environment





UFP processor

Equipped with Ultra-Fast processor, the customized IC has ultra-high-speed channel processing capability. Not only can it quickly read CMOS shooting data and perform high-resolution sub-pixel processing, but also output high-precision data, etc.

SSHE-CMOS

SSHE-CMOS combines high speed and high dynamic range, and is a specialized component for 3D laser profiler. For materials with different reflectivity, brightness does not need to be adjusted. It can stably measure all target objects, achieving high sensitivity and wide dynamic range. Even with extremely short exposure times (10 μm), it can accurately measure objects with black (low reflection) or even glossy surfaces (high reflection).

Introduction to **UFP Processing Function**

Through ultra-high-speed sampling and output, online quality inspection during production

can be achieved.

By averaging multiple high-speed sampled data, more stable measurement results can be obtained.

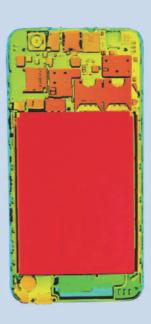
Through ultra-high-speed sampling processing, both height and grayscale information can be output simultaneously, with a maximum sampling speed of 214M contour points per second.

Mobile Phone Frame Accessory Detection

No need for multiple 3D sensors to be spliced or scanned multiple times, scanning one time by one device can obtain complete 3D data of the phone frame, which can detect the accessories inside the frame while ensuring accuracy and greatly improving detection efficiency.



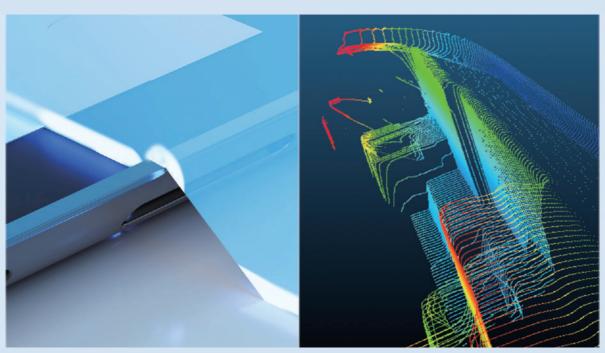




Detection of Length, Width and R Angle Profile in Mobile Phone Frame

Through two 3D sensors, the inner side wall of the middle frame of the mobile phone is scanned in a 45° cross-installation manner, and at the same time, the length, width and corners in the middle frame are measured by stitching the point cloud images.

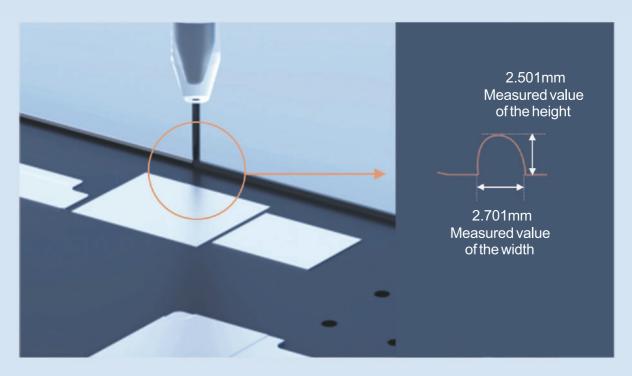




Glue Guiding + Glue Path Detection

Using high-precision 3D sensor, the middle frame is scanned before dispensing, and the three-dimensional coordinate information of the gluing path is accurately extracted, and the coordinate information is provided to the dispensing system to complete the dispensing guidance. After the glue coating is completed, the glue is scanned, the height and width of the glue are measured, and the coating quality is monitored. The guidance and re-inspection realized the closed-loop control of dispensing process, which greatly improved the production efficiency and product quality.

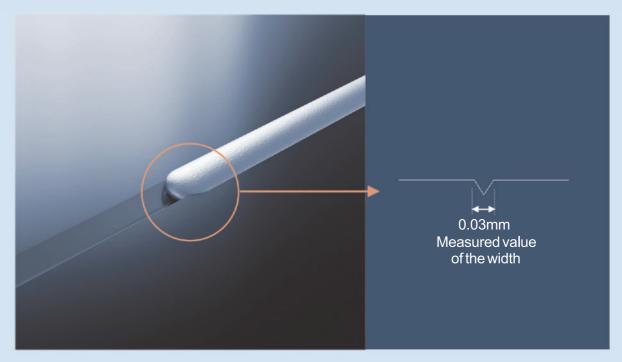




Welding Guide

In the laser welding process of non-standard workpiece, the welding robot is equipped with a 3D sensor to scan the welding groove and output the shape and position information of the groove to the welding robot in real time, so as to correct and guide the welding position, improve the welding accuracy and stability and reduce the production time.

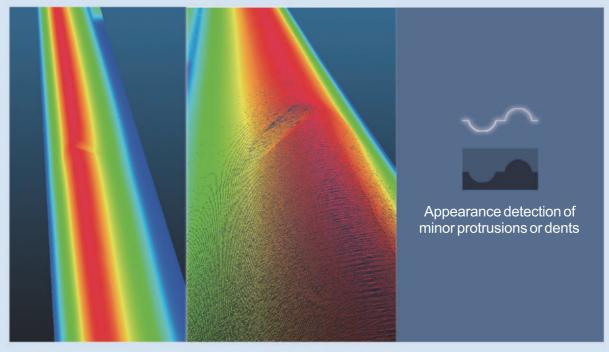




Welding Quality Inspection

Collect height and grayscale data through 3D sensors installed in a tilted manner as shown in the diagram. High-precision imaging can accurately detect defects such as bumps, dents, broken welds, pinholes, virtual welds, misalignment, and flanging in incoming materials. Avoiding leakage problems caused by welding quality and improving product stability and reliability.

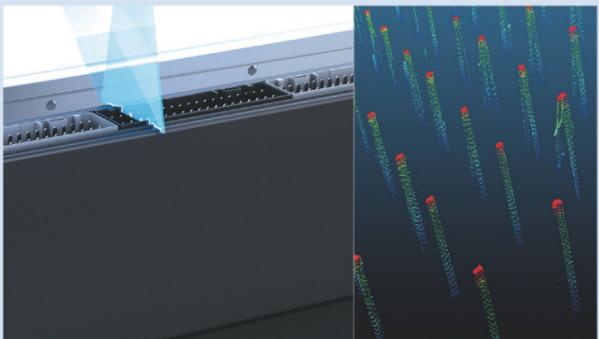




Connector Pin Detection

By using a non-contact measurement method, the top of the pin of the connector can be imaged accurately to measure the height, coplanarity, and positional accuracy of the pin.

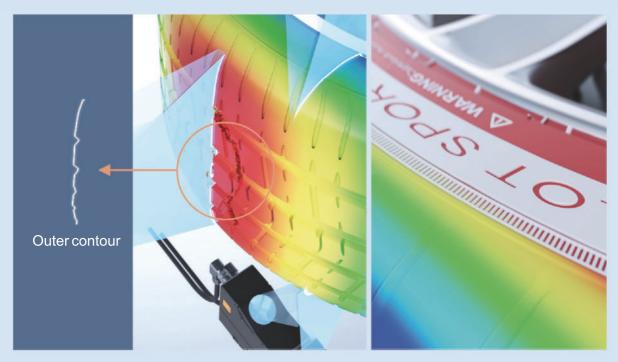




Quality Inspection of Tires

By scanning with three large-field view 3D sensors, the scanned 3D point cloud data is concatenated to obtain complete 3D information of the tire, which can control the dynamic balance, contour, and angular eccentricity of the tire, as well as detect character and defects on the tire surface.

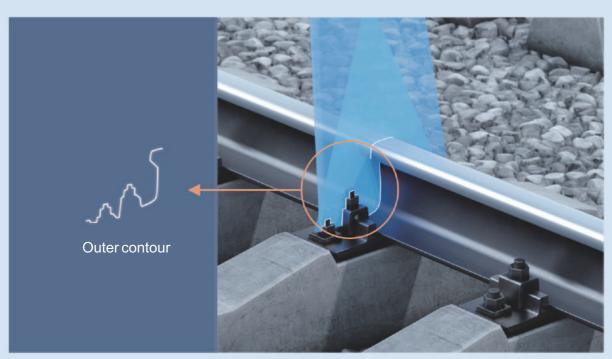




Track+Fastener Inspection

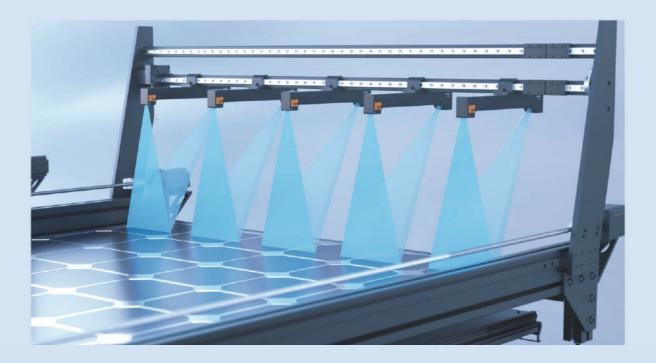
Use two 3D sensors to scan the left and right sides of the railway track respectively. The high-precision laser profiler has excellent outdoor anti-interference ability, accurately reproduces the three-dimensional images of the track and fasteners, and can detect rail wear, track spacing, fastener tightness, etc.

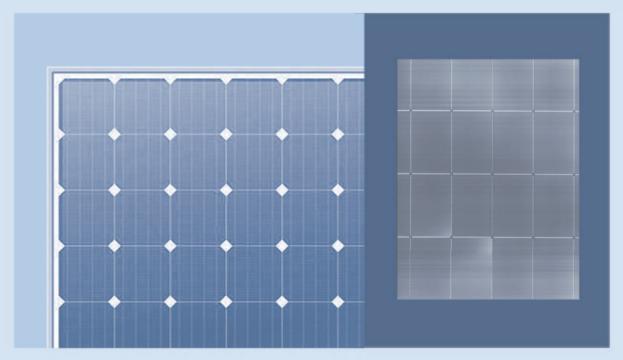




Silicon Wafer Overlapping Detection

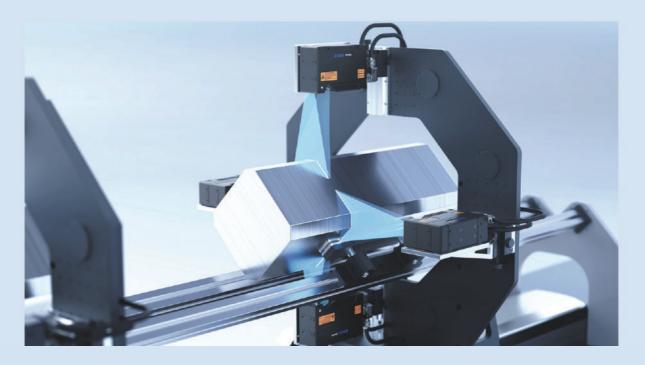
The comprehensive and one-time inspection of the wafer lapping carrier, foreign debris and carrier deformation significantly improves the inspection efficiency and ensures the high-precision various inspection requirements.





Silicon Rod Inspection

Four 3D sensors are installed on the same bracket, and each instrument is installed around the silicon rod in a 360° distribution, so as to construct an omni-directional scanning mode without blind areas. Through the spatial splicing technology, the three-dimensional data of silicon rods can be captured accurately in real time, including their size and radian changes, which ensures the consistency of silicon rods in the production process.

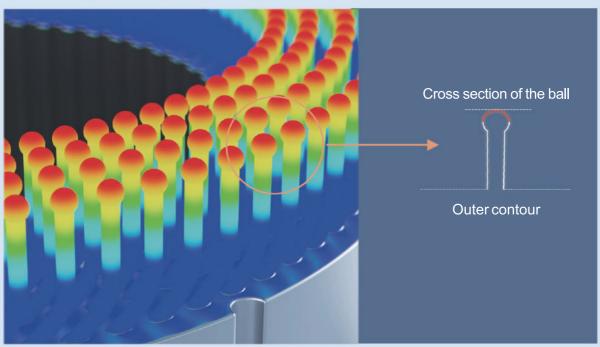




Quality Inspection of Soldering Balls for Motor Stator

Through the head-to-head installation of two 3D sensors, the blind area is effectively eliminated, and the defects such as insufficient wetting, missing solder, non-centered soldering and solder icicle of solder balls can be accurately detected.

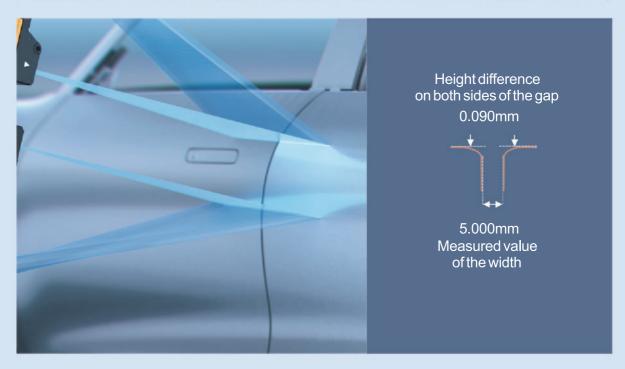




Connector Pin Detection

By head-to-head installing two 3D sensors and coordinating with a robotic arm for fast and precise positioning, it is possible to achieve blind spot free and real-time measurement of the gap width and segment difference of door seams, greatly improving detection efficiency compared to traditional detection methods.





Product Parameters

SRI7000 series

Parameter / Model	SRI7050	SRI7060	SRI7120R	SRI7080	SRI7140
Reference distance ① (CD)	50mm	60mm	120mm	80mm	140mm
Z-axis height (f.s.)	16mm	33mm	27mm	42.5mm	88mm
Upper visual field height	7.5mm	13.5mm	12.5mm	12.5mm 18mm	
Lower visual field height	8.5mm	19.5mm	14.5mm	24.5mm	54mm
X-axis width (near side)	26mm	34mm	41mm	51mm	70mm
X-axis width (Reference distance)	28mm	40mm	46mm	58mm	86mm
X-axis width (remote site)	30mm	49mm	53mm	69mm	110mm
Light source wavelength	405nm	405nm 650nm 405nm		405nm	405nm
Laser grade	2M	2M	2M	2M	2M
Laser output power	10mW	10mW 10mW 10mW 10mW		10mW	10mW
Z-axis linearity	±0.02%F.S.	±0.02%F.S.	±0.02%F.S.	±0.02%F.S.	±0.02%F.S.
Z-axis repeatability ^③	0.2µm	0.3µm	0.6µm	0.4µm	0.5μm
X-axis repeatability ⁽⁴⁾	2.5µm	4µm	4μm	5μm	7.5µm
X-axis data interval ^⑤	10μm	15μm	16µm	20µm	30μm
X-axis contour points	3200				
Scanning speed (Hz)	1500~20000		2800~20000	1500~20000	
Input voltage (power)	DC 24V(45W)				
Dimension (mm)	165.5 x 54 x 94.5	150.5 x 54 x 94.5	136 x 54 x 118	155.5 x 54 x 94.5	155.5 x 54 x 94.5
Weight (g)	1100	1020	1000	1150	1000

Notes: ①The recommended optimal installation distance corresponds to the diffuse reflection mode for this parameter. ②The value under the condition of nominal or increased contour data interval ③The data is obtained by measuring the object using our company's standard object and averaging over 64 profiles in a single scan ④ The value under the condition of nominal contour data interval ⑤The nominal contour data interval.

Parameter / Model	SRI7240	SRI7400R	SRI7300	SRI7700	SRI7900	SRI71600
Reference distance ① (CD)	240mm	400mm	270mm	700mm	833mm	1070mm
Z-axis height (f.s.)	153mm	339mm	347mm	315mm	710mm	1530mm
Upper visual field height	59mm	115mm	102mm	140mm	230mm	380mm
Lower visual field height	94mm	224mm	245mm	175mm	450mm	1150mm
X-axis width (near side)	115mm	146mm	225mm	357mm	320mm	745mm
X-axis width (Reference distance)	142mm	195mm	320mm	405mm	435mm	1120mm
X-axis width (remote site)	185mm	300mm	540mm	460mm	670mm	2250mm
Light source wavelength	405nm	660nm	450nm	450nm	450mm	450nm
Laser grade	2M	2M	3R	3R	3R	3R
Laser output power	10mW	10mW	50mW	50mW	50mV	50mW
Z-axis linearity	±0.02%F.S.					
Z-axis repeatability ^③	1μm	5μm	8µm	10μm	12µm	100µm
X-axis repeatability ④	13µm	20μm	25μm	37.5μm	40μm	125µm
X-axis data interval ⑤	50μm	90µm	100µm	150μm	180µm	500μm
X-axis contour points	3200					
Scanning speed (Hz)	1500~20000		2000~20000	1500~20000	2000~20000	2500~20000
Input voltage (power)	DC 24\	V(45W)	DC 24V(60W)			
Dimension (mm)	200 x 54 x 100	200.5 x 54 x 94	218 x 67 x 116	600 x 58 x 86	300x67x105	294.5 x 59 x 102
Weight (g)	1200	1200	2000	3000	2305	1805

Notes: ①The recommended optimal installation distance corresponds to the diffuse reflection mode for this parameter. ②The value under the condition of nominal or increased contour data interval ③The data is obtained by measuring the object using our company's standard object and averaging over 64 profiles in a single scan ④ The value under the condition of nominal contour data interval ⑤The nominal contour data interval.

SRI8000 series

Parameter / Model	SRI8020	SRI8060	SRI8065E	SRI8120	
Reference distance ① (CD)	23mm	60mm	60mm	118mm	
Z-axis height (f.s.)	5.2mm	18mm	14mm	68mm	
Upper visual field height	2.3mm	8mm	6mm	29mm	
Lower visual field height	2.9mm	10mm	8mm	39mm	
X-axis width (near side)	13mm	26mm	18mm	70mm	
X-axis width (Reference distance)	14.5mm	31mm	20mm	84mm	
X-axis width (2) (remote site)	16.0mm	36mm	21mm	100mm	
Light source wavelength	405nm	405nm	405mm	405mm	
Laser grade	2M	2M	2M	2M	
Laser output power	10mW	10mW	10mV	10mW	
Z-axis linearity	±0.02%F.S.	±0.02%F.S.	±0.02%F.S.	±0.01%F.S.	
Z-axis repeatability ^③	0.1μm	0.2μm	0.12μm	0.45μm	
X-axis repeatability (4)	1.5µm	5μm	1.5µm	7.5µm	
X-axis data interval	5μm	12μm	5.5µm	30µm	
X-axis contour points	3200				
Scanning speed (Hz)	3200~	67000	2300~67000		
Input voltage (power)	DC 24V(36W)				
Dimension (mm)	135.5 x	58 x 98	135.5 x 58 x 98		
Weight (g)	9.	70	970		

Notes: ①The recommended optimal installation distance corresponds to the diffuse reflection mode for this parameter. ②The value under the condition of nominal or increased contour data interval ③The data is obtained by measuring the object using our company's standard object and averaging over 64 profiles in a single scan ④ The value under the condition of nominal contour data interval ⑤The nominal contour data interval.

Parameter / Model	General parameters of products		
Temperature characteristics	0.01%F.S./°C		
Data interface	1 Ethernet interface 100Base-TX/1000Base-T		
Input	Differential encoder (trigger), start signal		
Working temperature	0~50°C		
Storage temperature	-20∼70°C		
Working humidity	35%~85% No condensation		
ESD Protection	Contact discharge 4kV, air discharge 8kV, comply with IEC 61000-4-2		
EFT protection	Power port 2kV/5 or 100kHz, signal port 1kV/5 or 100kHz, comply with IEC61000-4-4		
Shock resistance	Each axis 15Gs/6ms,comply with IEC 68-2-27 Ea		
Vibration resistance	10-150Hz, 2G, 2.5h per X, Y, Z axis, comply with IEC 68-2-6 Fc.		
Protection level	IP67, comply with IEC 60529		

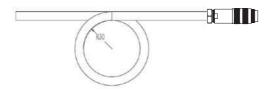
Product Parameters

		Cable Model of SRI Integrated 3D Laser Profiler				
IP Rating	3	IP67, comply with IEC 60529 ①				
Minimum c bending ra (Fixed)	dius	30mm				
Service	life	The radius is not less than 72mm (100mm is recommended), and the number of repeated bends is > 10 million. ②				
Camera m	nodel	SRI7000/SRI8000				
Name		Network cable		I/O cable		
		L-shaped joint (For L-shaped assembly)	I-shaped joint (For straight-shaped assembly)	L-shaped joint (For L-shaped assembly)	I-shaped joint (For straight-shaped assembly)	
	3m	SCB-HNET-HR2Z-3m	SCB-HNET-HB2Z-3m	SCB-HO-HR2Z-3m	SCB-HIO-HB2Z-3m	
General	6m	SCB-HNET-HR2Z-6m	SCB-HNET-HB2Z-6m	SCB-HO-HR2Z-6m	SCB-HIO-HB2Z-6m	
	10m	SCB-HNET-HR2Z-10m	SCB-HNET-HB2Z-10m	SCB-HO-HR2Z-10m	SCB-HIO-HB2Z-10m	
Customized	20m	SCB-HNET-HR2Z-20m	1	SCB-HO-HR2Z-20m	/	
Extended cable	5m	SCB-HNET-HR2YZ-5m	SCB-HNET-HB2Z-5m	SCB-HO-HR2YZ-5m	SCB-HIO-HB2Z-5m	

Notes: ① The value when the sensor head is connected, excluding the connector of the controller. ② Test environment: temperature 23°C, humidity 40%RH;
Test conditions: cable carrier radius: 72mm; Measurement results: standard value > 30 million times: minimum value > 10 million times. Cable carrier working range: 1000mm, running speed: 60 round/minute.

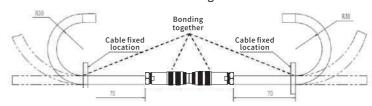
Precautions for Using Cables





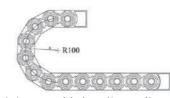
Minimum cable bending radius

When a splice is required, the splice head and the cable within 70mm of each end must be kept relatively fixed.



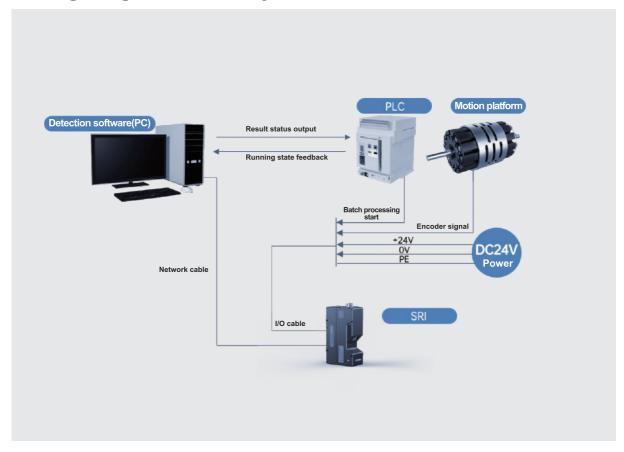
Cable splice connection

When using cable carriers, if not specifically specified, please choose products with R100 or higher.



Minimum cable bending radius

Wiring Diagram of The System



DIMENSIONS

Product Dimensions >

SRI7000 Series

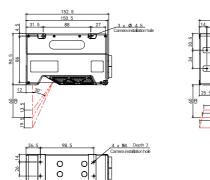
SR18000 Serie

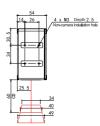
Product Dimensions

SRI7050

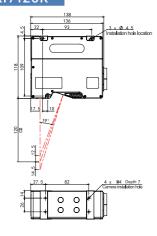
167. 5 165. 5 39. 5 87 31. 5 Cemera restablion hole

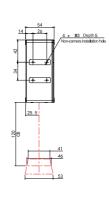
SRI7060



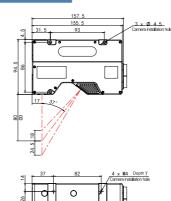


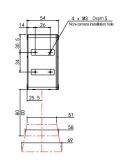
SRI7120R



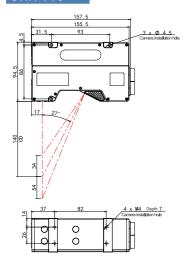


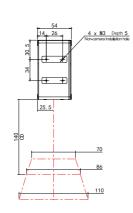
SRI7080





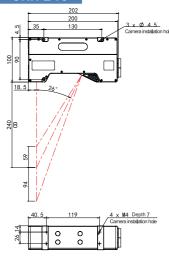
SRI7140

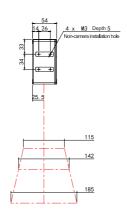




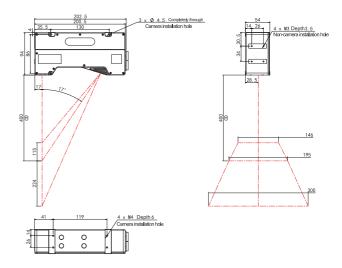
Product Dimensions

SRI7240

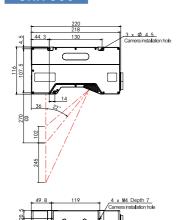


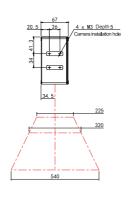


SRI7400R

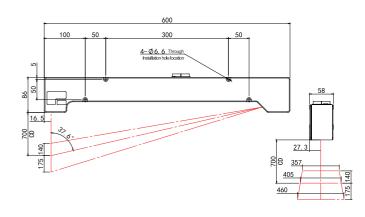


SRI7300

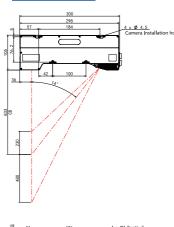


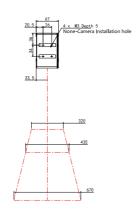


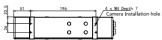
SRI7700



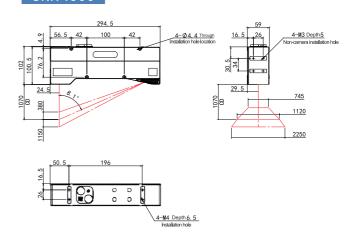
SRI7900



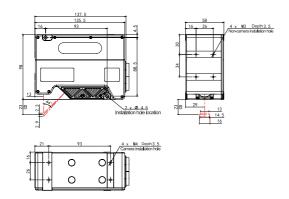




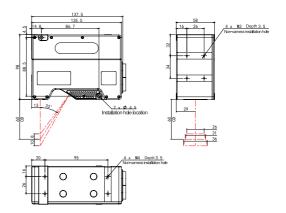
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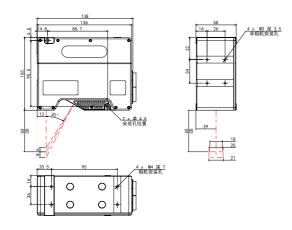
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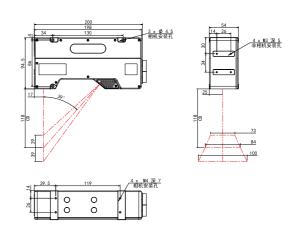
SRI8060



SRI8065E



SRI8120



Service covering:

China: Shenzhen, Suzhou (Kunshan), Shanghai, Wuxi, Beijing, Chengdu, Ningde, Taiwan, Wuhan, Xi'an, Hefei, Dongguan b Overseas: South Korea, Vietnam, Thailand, Malaysia, Singapore

SHENZHEN SINCEVISION TECHNOLOGY CO., LTD.

Headquarters:

5th Floor, Building 2, Chongwen Industrial Park, Nanshan Zhiyuan, Nanshan District, Shenzhen, China
Dongguan Office:

Room 406, Building F4, Tian'an Digital City, Nancheng District, Dongguan City, Guangdong Province, China

North China Office:

Room 808, Building 3, Jinmao Plaza, Auto Museum East Road, Fengtai District, Beijing, China East China Office:

Room 1305, Building 7, Xiangyu Liang'an Trade Center, No.1588, Chuangye Road, Kunshan, Jiangsu Province, China Southwest China Office:
Room 604, Block B, Yingchuang International Building, No. 66, Chuangzhi South 1st Road, Pidu District, Chengdu

Room 604, Block B., Tingenous, S. Tingenous,







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